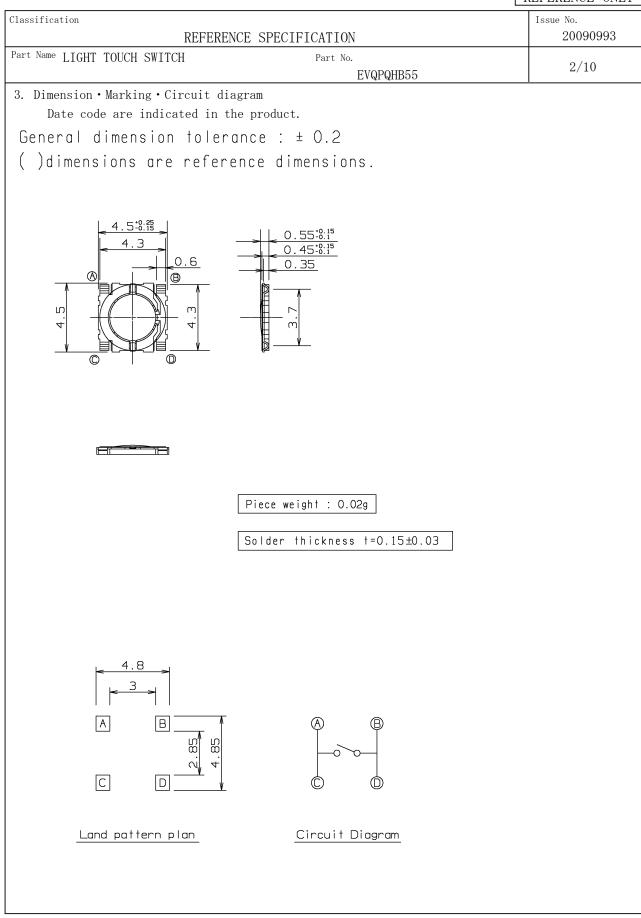
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Classification REFERENCE SPECIFICATION	Issue No. 20090993
Part Name LIGHT TOUCH SWITCH Part No. EVQPQHB55	1/10
<ol> <li>Notification Items         <ol> <li>1 Law and the regulation which are applied                 <ol></ol></li></ol></li></ol>	ertain /95/EC). Concerning at is subject
1.2 Application Limits This product was designed and manufactured for general electronics devices appliances, office equipment, data and communication equipment. For the following applications in which high reliability and safety are re the applications in which the failure or malfunction of the products may d jeopardize life or cause threat of personal asset, please contact us befo ·Aircraft and aerospace equipment, anti-disaster or anti-crime equipment, equipment, transport equipment(automotives, trains, boat etc), high pu information processing devices or the other equipments or devices that equivalent to the above mentioned.	quired, or for irectly rehand. medical blic
<ul> <li>1.3 Handling of reference specification.</li> <li>Since the contents of this reference specification are subjected to chang prior notifications, please request us a formal specification again for yo investigations before using.</li> </ul>	
1.4 Manufacturing Sites	
① The country of manufacture : Japan Panasonic Electronic Devices Japan Co., Ltd.	
<ol> <li>Summary</li> <li>This specifications applies to the following types of switch. Push-ON type S.P.S.T</li> </ol>	
2.2 This specifications is a constituent document of contract for business co your company and Panasonic Corporation.	ncluded between
2.3 Items not particularly specified in this specifications shall be in confo JIS Standards.	ormance with

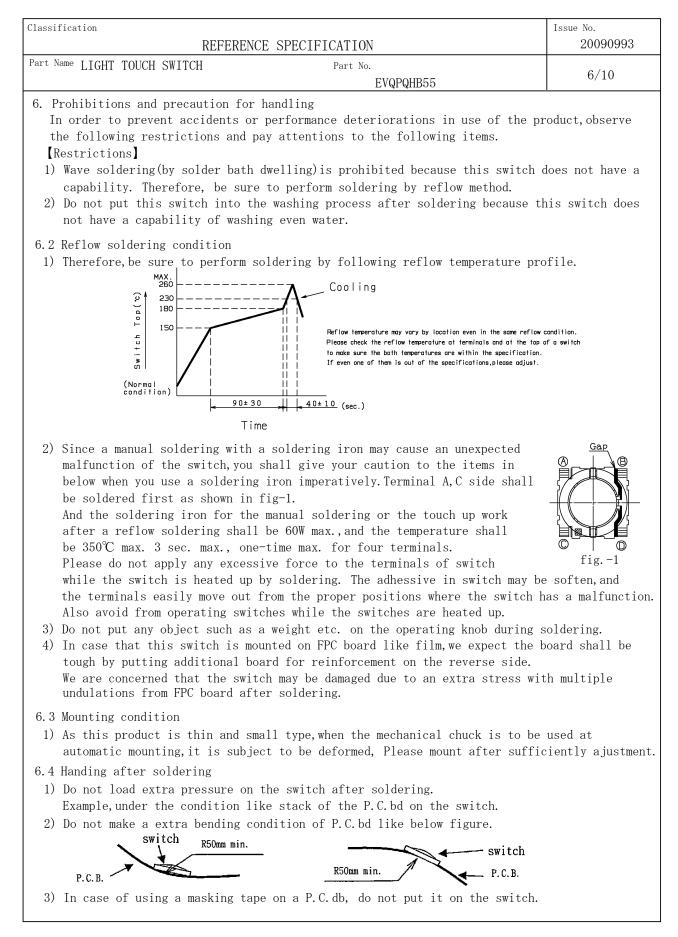
## REFERENCE ONLY



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Part Name LIGHT TOUCH SWI	TCH Part No. EVQPQHB55	3/10	
<ol> <li>General specification</li> <li>4.1 Switch rating</li> </ol>		μA(min.)	
4.2 Operation temperat			
4.3 Preservative temperature range Single condition : -40~+85 ℃ Taping condition : -20~+60 ℃			
Ambient tem	e specified, the test and measurements shall be ca perature:5 ${\sim}35~\%$ midity :45 ${\sim}85~\%$	rried out as follows.	
However, if doub under the above- employed. Ambient tem	ot arises on the decision based on the measured va -mentioned conditions, the following conditions sh mperature: $20\pm 2^{\circ}$ C midity : $65\pm5$ %		
<ol> <li>Performance</li> <li>1 Electrical charact</li> </ol>	teristics		
No. ITEM	TEST CONDITION	PERFORMANCE	
5.1.1 Contact resistance	Push force : {Operation force} $\times$ 2 Measurement tool : Contact resistance meter (Capable of 10 $\mu$ A $\sim$ 10 mA)	100 m $\Omega$ max.	
5.1.2 Insulation resistance	DC 100 V (Between terminals)	50 M $\Omega$ min.	
5.1.3 Withstand voltage	AC 250 V for 1 minute. (Between terminals)	No insulation destruction	
5.1.4 Bouncing	Operation speed : 3~4 times/s D. C. 10V 10kΩ 1mA Switch Bouncing Test Circuit	ON 3 ms max. OFF 10 ms max.	

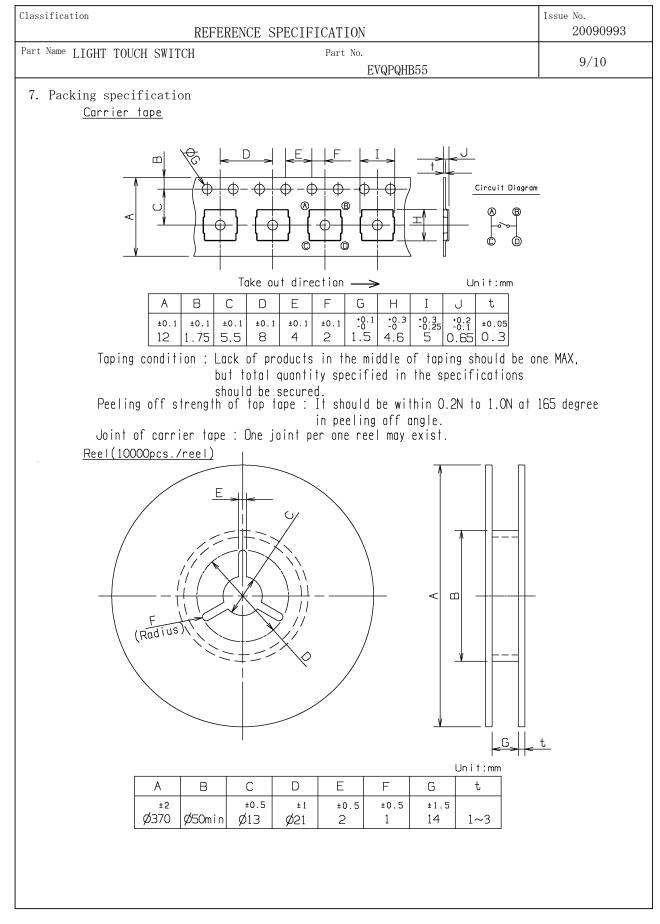
art Name	LIGHT TOUCH SW	VITCH Part No.		4/10
		EVQPQHB55		4/10
5.2 Me	chanical charac	teristics		
No.	ITEM	TEST CONDITION	PERFORMANCE	
5. 2. 1	Operation force	Push force Return force Stroke	Push for Return f	1.6 $^{+0.5}_{-0.5}$ N
5. 2. 2	Travel to closure	Stroke	0.20	+ 0. 10 - 0. 10 mm
5. 2. 3	Push strength	50 N for 15 sec.	No damag (Electri me	
5.2.4	Vibration test	<ol> <li>Amplitude : 1.5 mm</li> <li>Sweep rate : 10-55-10Hz for 1 minute</li> <li>Sweep method : Logarithmic frequency sweep rate</li> <li>Vibration direction : X, Y, Z(3 directions)</li> <li>Time : Each direction 2 hours (Total 6 hours)</li> </ol>	No.5.1 au 5.2.1 to be satis:	5.2.2 shall
5. 2. 5	Soldering heat test	Mount the switch on P.W.B by adhesive. 1) Reflow process 2 times. (Refer to section 6.1) 2) Standard conditions after test : 1 hours	100 mΩ 1 No. 5. 1. 2 No. 5. 2. 1	resistance max. to 5.1.4 and to 5.2.2 satisfied.
5. 2. 6	Solderbility	After spreading flux, the terminal is immersed in solder with following condition. Solder ber : M705/Sn-3.0Ag-0.5Cu (Senju Metal Indusry Co.,Ltd.) Flux : CF-110VH-2A (tamura kaken) Soldering temperture : 260±5℃ Soldering time : 2±0.5 sec.	area(Exc surface) immersed	ore of surface luding ruptured where is in solder covered by new

assifica	11011	REFERENCE SPECIFICATION	Issue No. 20090993	
rt Name	LIGHT TOUCH SW		5/10	
5.3 Cli	imatic character	ristics		
No.	ITEM	TEST CONDITION	PERFORMANCE	
5. 3. 1	Cold test	<ol> <li>1) Temperature : -40±2 °C</li> <li>2) Duration of test : 500 h</li> <li>3) Take off a drop water.</li> <li>4) Standard conditions after test : 1 h</li> </ol>	Contact resistance 200 m $\Omega$ max. No. 5. 1. 2 to 5. 1. 4 and No. 5. 2. 1 to 5. 2. 2 shall be satisfied.	
5. 3. 2	Heat test	<ol> <li>Temperature : 85±2 ℃</li> <li>Duration of test : 500 h</li> <li>Standard conditions after test : 1 h</li> </ol>	Contact resistance 200 m $\Omega$ max. No. 5. 1. 2 to 5. 1. 4 and No. 5. 2. 1 to 5. 2. 2 shall be satisfied.	
5. 3. 3	Heat shock test	1) Test cycles : 20 cycles 2) Standard conditions after test : 1 h A $A:+85\pm2$ °C B:-40\pm2 °C C:1 hour D:5 minutes max. E:1 hour F:5 minutes max.	Contact resistance 200 m $\Omega$ max. No. 5. 1. 2 to 5. 1. 4 and No. 5. 2. 1 to 5. 2. 2 shall be satisfied.	
5.3.4	Humidity test	<ol> <li>Temperature : 60±2 °C</li> <li>Relative humidity : 90~95 %</li> <li>Duration of test : 500 h</li> <li>Take off a drop water.</li> <li>Standard conditions after test : 1 h</li> </ol>	Contact resistance 200 m $\Omega$ max. No. 5. 1. 2 to 5. 1. 4 and No. 5. 2. 1 to 5. 2. 2 shall be satisfied.	
5.3.5	Endurance (Switching action)	<ol> <li>DC 15 V 20 mA Resistance load</li> <li>Operation speed : 2~3 times/s</li> <li>Push force : Maximum value of operation force</li> <li>Operation number : 200,000 times</li> </ol>	Contact resistance $200m \ \Omega$ max. Bouncing : 10 ms max. Variation rate of operation force shall be within $\pm 30 \ \%$ to the value before testing No. 5. 1. 2 and 5. 2. 2 shall be satisfied.	
5. 3. 6	Withstand H <sub>2</sub> S	<ol> <li>Density : 3±1 ppm</li> <li>Temperature : 40±2 ℃</li> <li>Relative humidity : 80~85 %</li> <li>Duration of test : 24 h</li> <li>Standard conditions after test : 1 h</li> </ol>	Contact resistance 200 m $\Omega$ max. No. 5. 1. 2 to 5. 1. 4 and No. 5. 2. 1 to 5. 2. 2 shall be satisfied.	



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Part Name LIGHT TOUCH SWITCH Part No. EVQPQHB55	7/10
<ul> <li>6.4 Attentions Required for Unit Design at customer side.</li> <li>1) When the soldering land pattern is to be designed with the recommended la and dimensions described in this Specifications for Information.</li> <li>2) Design the operating section on the setting side as shown in the Fig-1.</li> </ul>	ator 4° max. Fig-2 h a button due
<ul><li>with adhesives.Pay special attention to the terminal section. It may be a cau deformation, bad contact, or malfunction.</li><li>2) To prevent a bad contact caused by foreign particles (dust particles of P.W. Particles of flux) into the inside of the switch, pay attention to handle the mounting. And do not pile up the P.W.B</li></ul>	use of terminal B.,dust, ne P.W.B. after
<ul> <li>3) For storage of this product, avoid the place at high temperature and humidit corrosive gas may be generated. Especially for a long-term storage, do not the package and avoid storing with a loosed condition.</li> <li>4) Avoid pressing the film portion of the product with sharp-edged object.</li> <li>5) Please put your attention not to locate big amount of solder paste around like adding extra land patterns besides the switch, because flux ingress the switch may occur.</li> <li>6) This switch is for making a momentary signal. It is prohibited using the</li> </ul>	take out from the switch, to inside of
<ul> <li>(b) This switch is for making a momentary signal. It is prohibited using the function that expects long time signal (long time contact close).</li> <li>(c) There is a possibility the flux from solder paste infiltrates into the body solder paste was applied by switch on the P.W.B. So we recommend to use our proposed land design in order to prevent above proposed and by the switch on the P.W.B.</li> </ul>	if plenty of
<ul> <li>6.6 Attentions Required for Circuit Condition</li> <li>6.6.1 Rating <ul> <li>(1) In order to assure the reliability, use this product within the rating rang the Specifications.</li> <li>(2) Rated power is a maximum value of the power which can be continuous load at temperature.</li> <li>(3) If the product is used over the rated power, the correct characteristics ma or the product may be burnt.</li> </ul> </li> </ul>	rated ambient
<ul> <li>(4) The circuit shall be designed to avoid the inrush current to the switch, al surge voltage to be applied.</li> <li>(5) When the switches is used under a few μA (dry circuit), contact resistance circuit property, so please use the switch under specified switch rating.</li> </ul>	

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Part Name LIGHT TOUCH SWITCH	Part No.	
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	ion by chattering caused by bounching etc., please pay attention to the de	
temperature range specified	bility, use this product within the	e operating
(Except applications conside Avoid using this product in	er relative humidity of 85% min. for ered appropriate countermeasure) a place where it is directly expose nused by steam and dew condensation,	ed to the wheather,
<ul> <li>influence to characteristics</li> <li>(1) In the corrosive gas atm</li> <li>(2) Waterdrop remained, dew</li> <li>(3) In the solution of water</li> <li>(4) A place where it is expo</li> <li>(5) A place with large amount</li> <li>6.7.4 The structure of this product</li> <li>resistance. Do not wet with weight and</li> </ul>	ng circumstance and conditions as it s. nospere, such as Cl 2, H 25, NH 3, NOx, condensation, Waterdrop adhered. r, sale water, oil, chemicals, and c	SO 2 gas. organic solvents. ance and solvent
<pre>more than specified. 6.7.6 Push strength In order to avoid damages of section more than specified. (If the load is applied more of the push stroke, etc.)</pre>	the switch, do not apply the load to than specified, it may affect on the	o the operating e characteristics
	under pushed ON condition is continue	d for a long time.
be performed or soldering sec excessive stress and the temp		n not to apply
6.8.2 Pay attention not to melt the deformation.	e insulation material or the resin se	ection, and avoid



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EVQPQHB55	10/10
<pre><prohibitions and="" for="" handling="" precaution=""> [Prohibited items on fire and smoking]    Absolutely avoid use of a product beyond its rated range because doing so ma    If misuse or abnormal use may result under conditions in which the product rated range, take proper measures such as current interruption using a protect    The grade of nonflammability for resin used in product is "94HB," which is b    Standards (flammability test for plastic materials). Prohibit use in a locat    spreading fire may be generated or prepare against a spreading fire.</prohibitions></pre>	is used out of its tive circuit. pased on UL94
<ul> <li>(For use in equipment for which safety is requested)</li> <li>Although care is taken to ensure product quality, inferior characteristics, sh and open circuits are some problems that might be generated. To design an equipaces maximum emphasis on safety, review the effect of any single fault of a in advance and perform virtually fail-safe design to ensure maximum safety be 'Preparing a protective circuit or a protective device to improve system safety so that the single fault of a product does not cause a dangerous situation.</li> </ul>	quipment which a product y: fety,and equipment.
[Attentions required for storage condition] • When this product is to be stored in the following circumstances and conditi affect on the performance deteriorations and solderability etc., avoid storin following conditions. (1) A place where the temperature is -10°C max., +40°C min. and the humidity i (2) In the corrosive gas atmosphere. (3) Long-term storage for 6 months min. (4) A place where the product is exposed to direct sunlight. • Store in packed condition so that the load stress is not applied. • Please use this product as soon as possible, our recommendation is within 3 m limitation is 6 months. • If any remainder left after packing is opened, store it with proper moisturer gasproofing, etc.,	ng in the s 85% min. nonths and the